

v02.0111

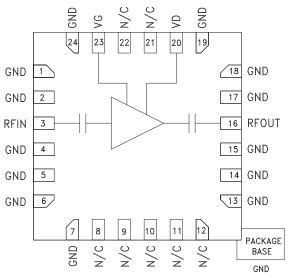


Typical Applications

The HMC863LP4E is ideal for:

- Point-to-Point Radios
- Point-to-Multi-Point Radios
- VSAT
- Military & Space

Functional Diagram



GaAs pHEMT MMIC ½ WATT POWER AMPLIFIER, 22 - 26.5 GHz

Features

Saturated Output Power: up to +27.5 dBm @ 15% PAE High Output IP3: +33 dBm High Gain: 21.5 dB DC Supply: +6V @ 350mA No External Matching Required 24 Lead 4x4 mm SMT Package: 16 mm²

General Description

The HMC863LP4E is a three stage GaAs pHEMT MMIC ½ Watt Power Amplifier which operates between 22 and 26.5 GHz. The HMC863LP4E provides 21.5 dB of gain, +27.5 dBm of saturated output power and 15% PAE from a +6V supply. High output IP3 makes the HMC863LP4E ideal for point-to-point and point-to-multi-point radio systems as well as VSAT applications. The RF I/Os are DC blocked and matched to 50 Ohms for ease of integration into higher level assemblies. The HMC863LP4E can also be operated from a 5V supply with only a slight decrease in output power & IP3.

Electrical Specifications, $T_A = +25^{\circ}$ C, Vdd = Vdd1 = Vdd2 = +6V, Idd = 350mA^[1]

Parameter	Min.	Тур.	Max.	Units
Frequency Range		22 - 26.5 GHz		GHz
Gain	19	21.5		dB
Gain Variation Over Temperature		0.032		dB/ °C
Input Return Loss		11		dB
Output Return Loss		15		dB
Output Power for 1 dB Compression (P1dB)	22	24.5		dBm
Saturated Output Power (Psat)		27		dBm
Output Third Order Intercept (IP3) ^[2]		33		dBm
Total Supply Current (Idd)		350	380	mA

[1] Adjust Vgg between -2 to 0V to achieve Idd = 350mA typical.

[2] Measurement taken at +6V @ 350mA, Pout / Tone = +14 dBm

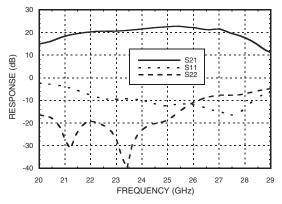
Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.



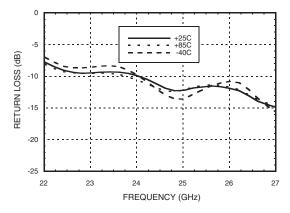
v02.0111



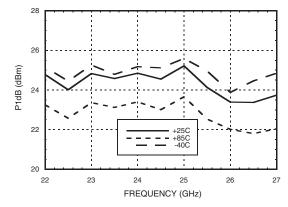
Broadband Gain & Return Loss vs. Frequency



Input Return Loss vs. Temperature

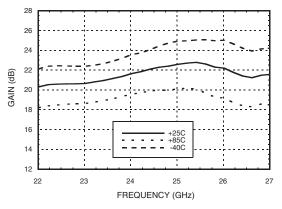


P1dB vs. Temperature

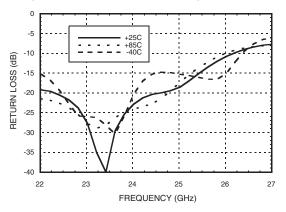


GaAs pHEMT MMIC ½ WATT POWER AMPLIFIER, 22 - 26.5 GHz

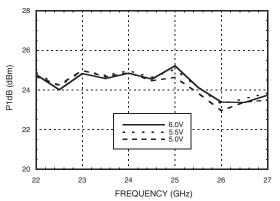
Gain vs. Temperature



Output Return Loss vs. Temperature



P1dB vs. Supply Voltage



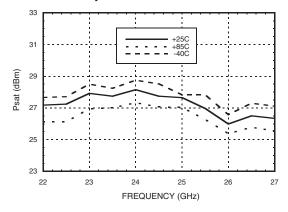
Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.



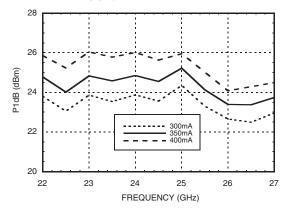
v02.0111



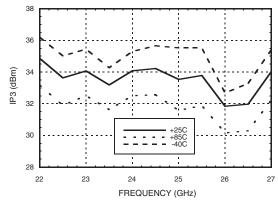
Psat vs. Temperature



P1dB vs. Supply Current (Idd)

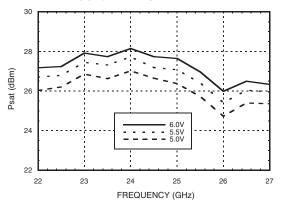


Output IP3 vs. Temperature, Pout/Tone = +14 dBm

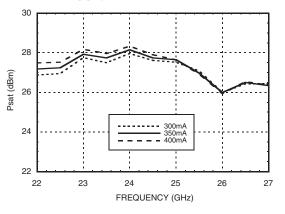


GaAs pHEMT MMIC ½ WATT POWER AMPLIFIER, 22 - 26.5 GHz

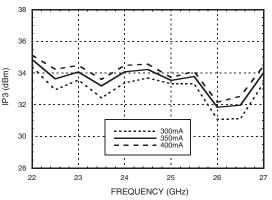
Psat vs. Supply Voltage



Psat vs. Supply Current (Idd)



Output IP3 vs. Supply Current, Pout/Tone = +14 dBm



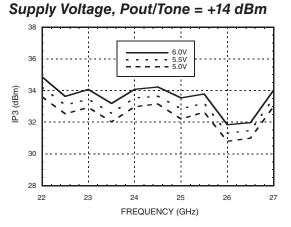
Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.



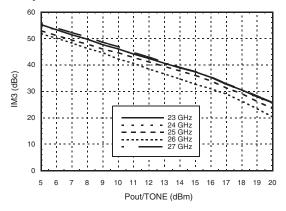
v02.0111



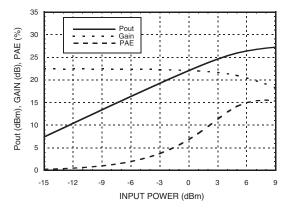
Output IP3 vs.



Output IM3 @ Vdd = +5.5V

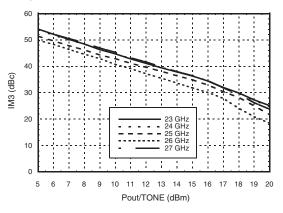


Power Compression @ 25 GHz

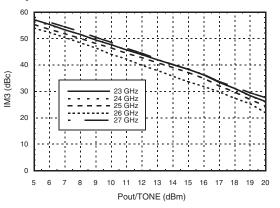


GaAs pHEMT MMIC ½ WATT POWER AMPLIFIER, 22 - 26.5 GHz

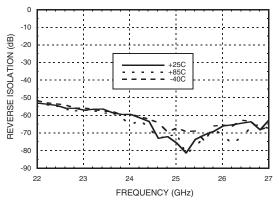
Output IM3 @ Vdd = +5V



Output IM3 @ Vdd = +6V



Reverse Isolation vs. Temperature



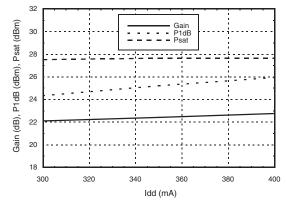
Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.



v02.0111

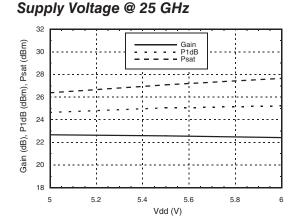


Gain & Power vs. Supply Current @ 25 GHz

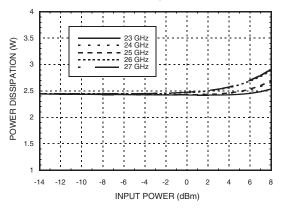


GaAs pHEMT MMIC ½ WATT POWER AMPLIFIER, 22 - 26.5 GHz

Gain & Power vs.



Power Dissipation



Absolute Maximum Ratings

Drain Bias Voltage (Vd)	6.3V
RF Input Power (RFIN)	+26 dBm
Channel Temperature	150 °C
Continuous Pdiss (T= 85 °C) (derate 37 mW/°C above 85 °C)	2.52 W
Thermal Resistance (channel to ground paddle)	26.9 C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-55 to +85 °C
ESD Sensitivity (HBM)	Class 0, 150V

Typical Supply Current vs. Vdd

Vdd (V)	Idd (mA)	
+5.0	350	
+5.5	350	
+6.0	350	

Note: Amplifier will operate over full voltage ranges shown above Vgg adjusted to achieve Idd = 350mA at +5.5V



Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

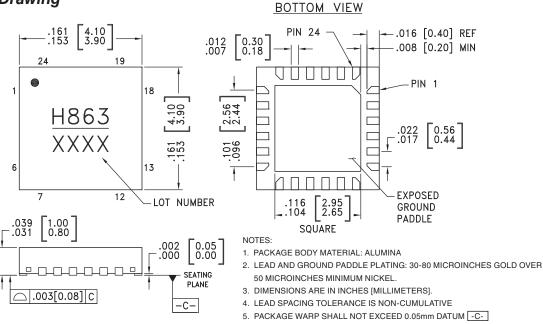


v02.0111



GaAs pHEMT MMIC ½ WATT POWER AMPLIFIER, 22 - 26.5 GHz

Outline Drawing



ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.

7. CLASSIFIED AS MOISTURE SENSITIVITY LEVEL (MSL) 1.

Package Information

[Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[1]
	HMC863LP4E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	<u>H863</u> XXXX

[1] 4-Digit lot number XXXX

[2] Max peak reflow temperature of 260 °C

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 2, 4 - 7, 12 - 15, 17 - 19, 24 Package Bottom	GND	Ground pins and package bottom must be connected to RF/DC ground.	
3	RFIN	This pin is AC coupled and matched to 50 Ohms.	
8 - 11	N/C	The pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.	
16	RFOUT	This pin is AC coupled and matched to 50 Ohms.	
20	Vd	Drain bias for amplifier. External 100 pF, 0.1 μF and 4.7 μF bypass capacitors are required.	
23	Vg	Gate control for PA. Adjust Vg to achieve recommended bias current. External 100 pF, 0.1 μF and 4.7 μF bypass capacitors are required.	Vg o

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.



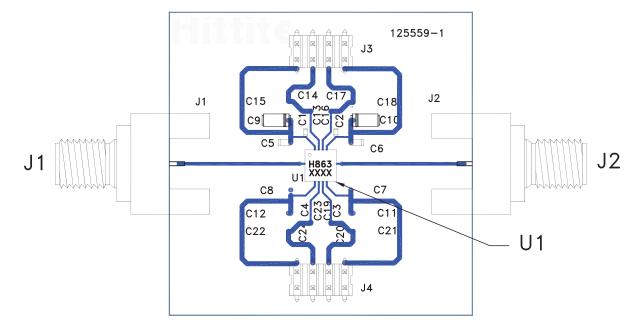
GaAs pHEMT MMIC 1/2 WATT

POWER AMPLIFIER, 22 - 26.5 GHz

v02.0111



Evaluation PCB



List of Materials for Evaluation PCB 130560 [1]

Item	Description	
J1 - J2	2.9 mm Connectors	
J3 - J4	DC Pins	
C1, C2	100 pF Capacitors, 0402 Pkg.	
C6	10 kpF Capacitor, 0402 Pkg	
C10	4.7 μF Capacitor, 0402 Pkg.	
U1	HMC863LP4E Power Amplifier	
PCB [2]	125559 Evaluation PCB	

 $\left[1\right]$ Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350 or Arlon FR4

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

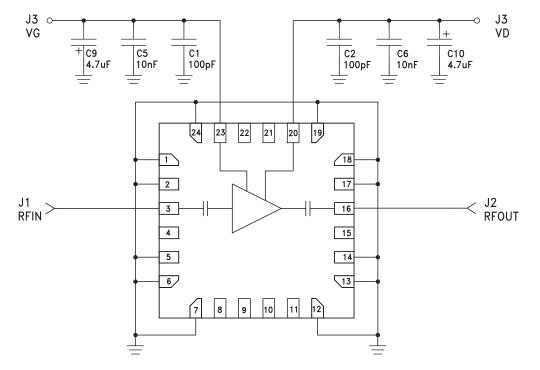


v02.0111



GaAs pHEMT MMIC ½ WATT POWER AMPLIFIER, 22 - 26.5 GHz

Application Circuit



Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.